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CLAIMS

- 1. Method of minimizing the "corner" effect in shallow trenches (26) of silicon oxide for laterally insulating active areas (21), characterized in that after depositing a layer (23) of silicon oxide into the trenches (26), said deposited layer is densified by irradiation with short wavelength light.
- 2. Method according to claim 1, characterized in that the oxide layer is densified by irradiating said layer with light at a wavelength less than or equal to 200 nm with a number of photons per cm² greater than 10¹⁹ and an energy at least equal to 9 eV.
- 3. Method according to claim 2, characterized in that the wavelength of the light is approximately 100 nm.
- 4. Method according to any of claims 1 to 3, characterized in that the layer (23) of silicon oxide deposited in the trenches (26) is densified directly after depositing said layer, before flattening it.